

## IN THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1           1.       (Currently Amended) A current-in-plane (CIP) GMR sensor, comprising:  
2           a GMR sensor stack having a width selected to provide a predetermined track  
3           width;  
4           a spacer layer, having a width substantially equal to the spin valve stack, formed  
5           over a free-layer of the GMR sensor stack; and  
6           an in-stack biasing layer disposed over the spacer and having a width substantially  
7           equal to the width of the GMR sensor stack.
- 1           2.       (Currently Amended) The CIP GMR sensor of claim 1, wherein the in-  
2           stack biasing layer comprises materials selected from the group consisting of NiFe, CoFe,  
3           NiFeCr, ~~NiFe<sub>x</sub>~~ and ~~CoFe<sub>x</sub>~~, NiFeX and CoFeX.
- 1           3.       (Currently Amended) The CIP GMR sensor of claim 1 further comprising  
2           ~~lead layers formed on either side of the GMR sensor stack~~ an antiferromagnetic layer  
3           formed on both sides of the in-stack biasing layer to provide an off-track bias layer.
- 1           4.       (Currently Amended) The CIP GMR sensor of claim 3, further comprising  
2           lead layers formed on either side of the GMR sensor stack, wherein the lead layers  
3           comprises a layer of Rhodium disposed adjacent to the GMR sensor stack; and a  
4           Tantalum layer formed over the layer of Rhodium and a layer of Platinum-Manganese  
5           formed over the layer of Tantalum.

1           5.       (Currently Amended) The CIP GMR sensor of claim [[ 4 ]] 3, wherein the  
2       antiferromagnetic layer comprises a layer of Platinum-Manganese ~~is formed adjacent a~~  
3       ~~portion of the in-stack bias layer.~~

1           6.       (Currently Amended) The CIP GMR sensor of claim 3, wherein the in-  
2       stack biasing layer comprises a bias layer formed only over the spacer and a coupling  
3       layer formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1           7.       (Currently Amended) The CIP GMR sensor of claim 6, wherein the bias  
2       layers and coupling layer each comprise a material selected from the group consisting of  
3       NiFe, CoFe, NiFeCr, ~~NiFe<sub>x</sub> and CoFe<sub>x</sub>~~ NiFeX and CoFeX.

1           8.       (Original)     The CIP GMR sensor of claim 1 further comprising a cap  
2       layer formed over the in-stack bias layer.

1           9.       (Currently Amended) A magnetic storage system, comprising:  
2           a magnetic storage medium having a plurality of tracks for recording of data; and  
3           a current-in-plane (CIP) GMR sensor maintained in a closely spaced position  
4 relative to the magnetic storage medium during relative motion between the magnetic  
5 transducer and the magnetic storage medium, the CIP GMR sensor further comprising:  
6           a GMR sensor stack having a width selected to provide a predetermined  
7 track width;  
8           a spacer layer, having a width substantially equal to the spin valve stack,  
9 formed over a free-layer of the GMR sensor stack; and  
10          an in-stack biasing layer disposed over the spacer and having a width  
11 substantially equal to the width of the GMR sensor stack.

1           10.       (Currently Amended) The magnetic storage of claim 9, wherein the in-  
2 stack biasing layer comprises materials selected from the group consisting of NiFe, CoFe,  
3 NiFeCr, ~~NiFe<sub>x</sub> and CoFe<sub>x</sub>~~ NiFeX and CoFeX.

1           11.       (Currently Amended) The magnetic storage of claim 9 further comprising  
2 ~~lead layers formed on either side of the GMR sensor stack~~ an antiferromagnetic layer  
3 formed on both sides of the in-stack biasing layer to provide an off-track bias layer.

1           12.   (Currently Amended) The magnetic storage of claim 11, , further  
2   comprising lead layers formed on either side of the GMR sensor stack, wherein the lead  
3   layers comprises a layer of Rhodium disposed adjacent to the GMR sensor stack; and a  
4   Tantalum layer formed over the layer of Rhodium ~~and a layer of Platinum-Manganese~~  
5   ~~formed over the layer of Tantalum.~~

1           13.   (Currently Amended) The magnetic storage of claim [[ 12 ]] 11, wherein  
2   the antiferromagnetic layer comprises a layer of Platinum-Manganese ~~is formed adjacent~~  
3   ~~a portion of the in-stack bias layer.~~

1           14.   (Currently Amended) The magnetic storage of claim 11, wherein the in-  
2   stack biasing layer comprises a bias layer formed only over the spacer and a coupling  
3   layer formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1           15.   (Currently Amended) The magnetic storage of claim 9, wherein the bias  
2   layer and the coupling layer each comprise a material selected from the group consisting  
3   of NiFe, CoFe, NiFeCr, ~~NiFe<sub>x</sub> and CoFe<sub>x</sub>~~ NiFeX and CoFeX.

1           16.   (Original)   The magnetic storage of claim 9 further comprising a cap  
2   layer formed over the in-stack bias layer.

1           17.     (Currently Amended) A method for providing a current-in-plane (CIP)  
2     GMR sensor with an improved in-stack bias layer with a thinner sensor stack,  
3     comprising;  
4           forming a thin spin valve stack having a width selected to provide a  
5     predetermined track width;  
6           forming a spacer over the spin valve stack, the spacer having a width substantially  
7     equal to the spin valve stack;  
8           forming lead layers in a passive region outside the track;  
9           forming, over the spacer, an in-stack bias layer having a width substantially equal  
10    to the width of the GMR sensor stack over the spacer for biasing a free-layer of the spin  
11    valve stack; and  
12           forming a cap over the bias layer.

1           18.     (Currently Amended) The method of claim 17, wherein forming the lead  
2     layers further comprises forming a layer of Rhodium disposed adjacent to the GMR  
3     sensor stack; and forming a Tantalum layer formed over the layer of Rhodium and a layer  
4     of Platinum-Manganese formed over the layer of Tantalum.

1           19.     (Currently Amended) The method of claim [[ 18 ]] 17, wherein the  
2     forming of the in-stack bias layer comprises forming a layer of Platinum-Manganese  
3     further comprises forming the layer of Platinum-Manganese adjacent a portion of the in-  
4     stack bias layer.

1           20.   (Currently Amended) The method of claim [[ 18 ]] 17, wherein the in-  
2   stack bias layer comprises a bias layer formed only over the spacer and a coupling layer  
3   formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1           21.   (Currently Amended) The method of claim 17, wherein the forming of the  
2   bias layer and the coupling layer each further comprises using a material selected from  
3   the group consisting of NiFe, CoFe, NiFeCr, ~~NiFe<sub>x</sub> and CoFe<sub>x</sub>~~ NiFeX and CoFeX.